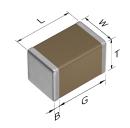
积层贴片陶瓷片式电容器

C2012JB1V225K125AB

RoHS Reach Halogen Free Pb Free

交货型号	C2012JB1V225KT****	
用途	一般等级	
特点	General 一般(~75V)	
系列	C2012 [EIA 0805]	
状态	↑ 量产体制(新设计非推荐) 推荐代替型号 : C2012X5R1V225K125AB (不保证其兼容性。)	



	尺寸
长度(L)	2.00mm ±0.20mm
宽度(W)	1. 25mm ±0. 20mm
厚度(T)	1. 25mm ±0. 20mm
端子宽度(B)	0.20mm Min.
端子间隔(G)	0.50mm Min.
推荐焊盘布局(PA)	1.00mm to 1.30mm(Flow Soldering)
1世存/开益41/四 (FA)	0.90mm to 1.20mm(Reflow Soldering)
推荐焊盘布局(PB)	1.00mm to 1.20mm(Flow Soldering)
证符/杆皿/印/印 (LD)	0.70mm to 0.90mm(Reflow Soldering)
推荐焊盘布局(PC)	0.80mm to 1.10mm(Flow Soldering)
1世代/产血作/内(11-0)	0.90mm to 1.20mm (Reflow Soldering)

ŧ	3气特性
电容	$2.2\muF~\pm10\%$
额定电压	35VDC
温度特性	JB(±10%)
耗散因数 (Max.)	5%
绝缘电阻 (Min.)	227ΜΩ

	其他	
焊接方法	流体	
件按刀伍	回流	
AEC-Q200	NO	
包装形式	塑封编带 (180mm卷筒)	
包装个数	2000pcs	

[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

 $^{! \ \}mbox{All specifications}$ are subject to change without notice.



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特性图表(这是参考数据,并不保证产品的特性。)

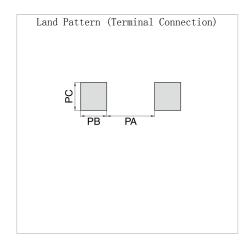
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Associated Images



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